

WG50N65MAW1

Rev.01 - 27 September 2023

Product data sheet

1. General description

WG50N65MAW1 uses advanced Fine Trench Field-stop IGBT technology with antiparallel diode in TO247 package to provide extremely low $V_{CE(sat)}$, and excellent switching performance. This device is ideal for wide range switching frequency power converters.



2. Features and benefits

- Maximum junction temperature 175 °C
- Positive Temperature efficient for Easy Parallel Operating
- Very soft, fast recovery anti-parallel diode
- Smooth & Optimized switching
- EMI Improved Design

3. Applications

- Motor control
- PFC
- UPS
- · Resonant converters
- · Mid to high switching frequency applications

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Parameter		Value			Unit
V_{CE}	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$				650		V
I _C	DC collector current, limited by $T_{j(max)}$ T _c = 100 °C				50		A
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static characteristics							
$V_{\text{CE(sat)}}$	Collector-emitter saturation voltage	V _{GE} = 15 V; I _C = 50 A; T _j = 25 °C		-	1.55	1.95	V

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol	
1	G	gate		۰C	
2	С	collector			
3	E	emitter			
mb	С	mounting base; connected to collector			G FE

6. Ordering information

Table 3. Ordering information								
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date		
WG50N65MAW1	TO247	WG50N65MAW1Q	Tube	30	SOT429	25-Mar-2013		

7. Marking

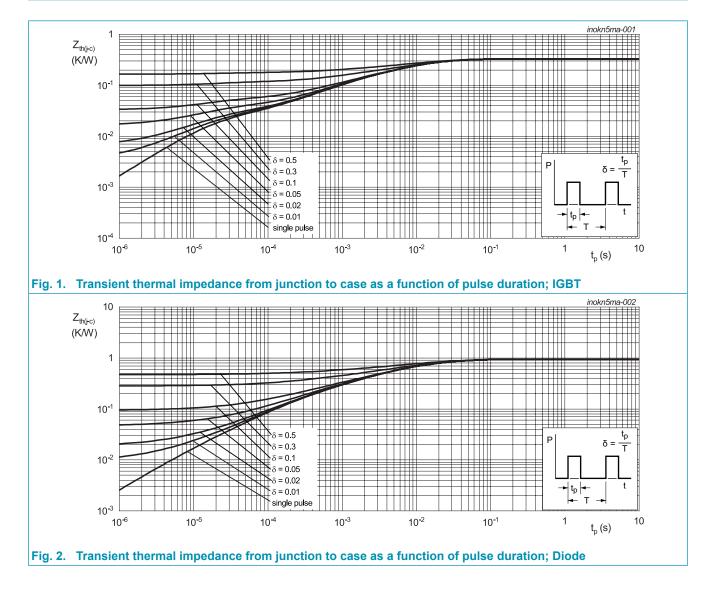
Table 4. Marking codes		
Type number	Marking codes	
WG50N65MAW1	G50N65	
	MAW1	

8. Limiting values

Symbol	Parameter	Notes	Value	Unit
V _{CE}	Collector-emitter voltage, $T_j \ge 25 \text{ °C}$		650	V
I _c	DC collector current, limited by $T_{j(max)}$ T _c = 25 °C T _c = 100 °C		100 50	А
I _{C(puls)}	Pulsed collector current, t_p limited by $T_{j(max)}$		150	А
-	Turn off safe operating area $V_{CE} \le 650 \text{ V}, \text{ T}_{j} \le 175 \text{ °C}, \text{ t}_{p} = 1 \mu\text{s}$		150	A
I _F	Diode forward current, limited by $T_{j(max)}$ $T_{c} = 25 \text{ °C}$ $T_{c} = 100 \text{ °C}$		60 30	A
I _{Fpuls}	Diode pulsed current, t_p limited by $T_{j(max)}$		90	А
V_{GE}	Gate-emitter voltage		±20	V
P _{tot}	Power dissipation $T_c = 25 \degree C$ Power dissipation $T_c = 100 \degree C$		454 227	W
t _{sc}	Short circuit withstand time $V_{GE} = 15.0 \text{ V}, V_{CC} \le 400 \text{ V}$ Allowed number of short circuits < 1000 Time between short circuits: $\ge 1.0 \text{ s}$ $T_j = 125^{\circ}\text{C}$		5	us
T _{stg}	Storage temperature		-55 to +150	°C
T _{jmax}	Maximum operating junction temperature		175	°C
-	Peak soldering temperture		260	°C
М	Mounting Torque with washer		0.55	Nm

9. Thermal characteristics

Table 6. Thermal characteristics							
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
R _{th(j-c)}	IGBT thermal resistance from junction to case			-	0.33	-	K/W
R _{th(j-c)}	Diode thermal resistance from junction to case			-	0.94	-	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient			-	40	-	K/W



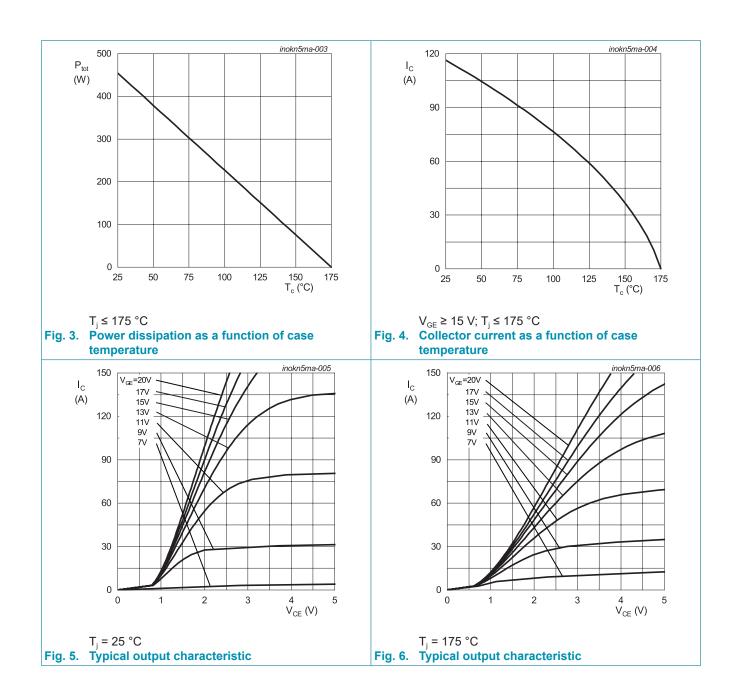
10. Characteristics

Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
Static cha	racteristics						
BV_{CES}	Collector-emitter breakdown voltage	$V_{ge} = 0 \text{ V}; \text{ I}_{c} = 50 \mu\text{A}$		650	-	-	V
$V_{\text{CE(sat)}}$	Collector-emitter saturation voltage	V _{GE} = 15 V; I _C = 50 A; T _j = 25 °C		-	1.55	1.95	V
		V _{GE} = 15 V; I _C = 50 A; T _j = 175 °C		-	2	-	V
V _F E	Diode forward voltage	V _{GE} = 0 V; I _F = 30 A; T _j = 25 °C		-	1.9	-	V
		V _{GE} = 0 V; I _F = 30 A; T _j = 175 °C		-	1.5	-	V
$V_{\text{GE(th)}}$	Gate-emitter threhold voltage	I _C = 0.5 mA; V _{CE} = V _{GE}		4.3	5.4	6.5	V
I _{CES}	Zero gate voltage collector current	V _{CE} = 650 V; V _{GE} = 0 V; T _j = 25 °C		-	-	100	μA
		V _{CE} = 650 V; V _{GE} = 0 V; T _j = 175 °C		-	-	1	mA
g _{fs}	Transconductance	V _{CE} = 20 V; I _C = 50 A		-	24	-	S
Dynamic	characteristics	· ·					
C _{ies}	Input capacitance	V _{CE} = 30 V; V _{GE} = 0 V; f = 1 MHz;		-	2968	-	pF
C _{oes}	Output capacitance	T _j = 25 °C		-	113	-	pF
C _{res}	Reverse transfer capacitance			-	40	-	pF
Q_{G}	Gate charge	V _{CC} = 520 V; I _C = 50 A; V _{GE} = 15 V; T _i = 25 °C		-	133	-	nC

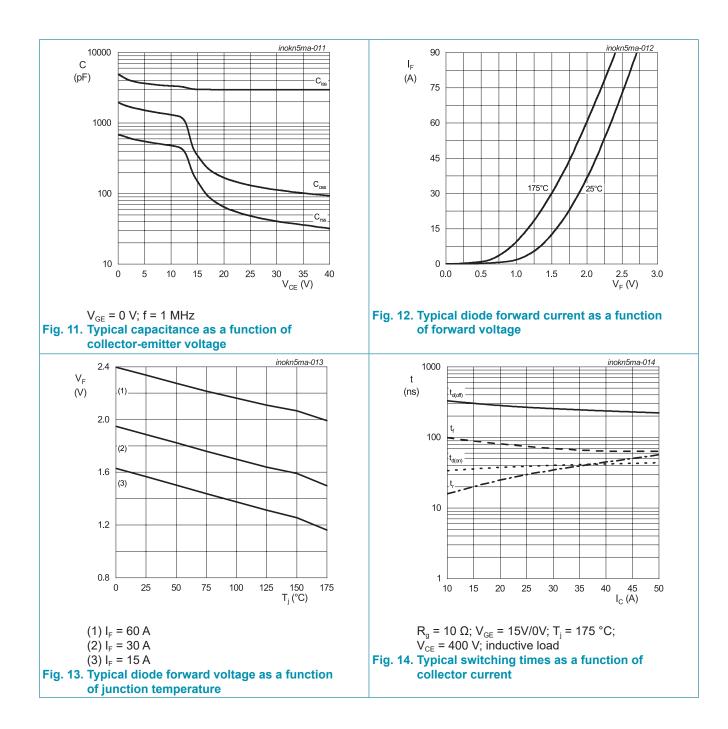
11. Switching Characteristics

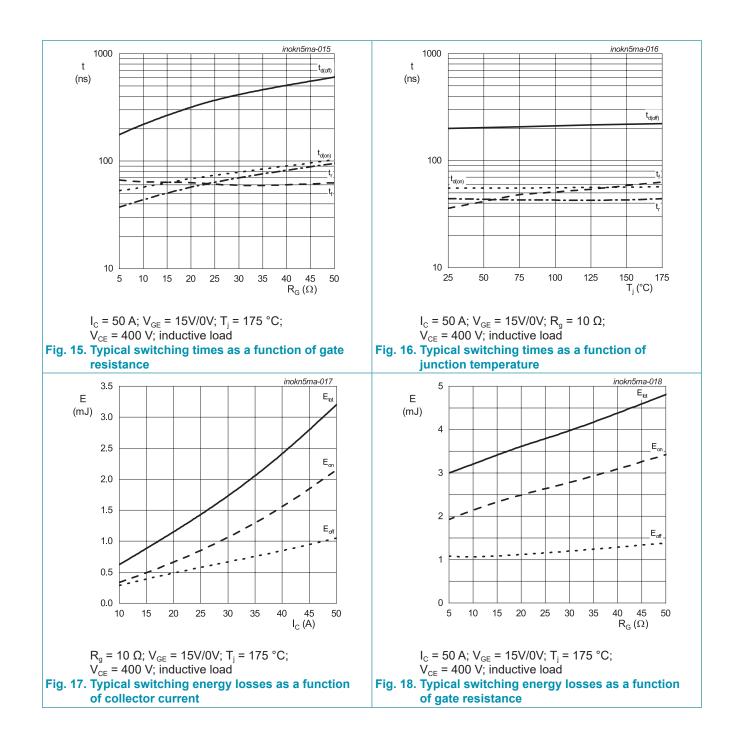
Table 8. S	witching Character	istics, Inductive Load	

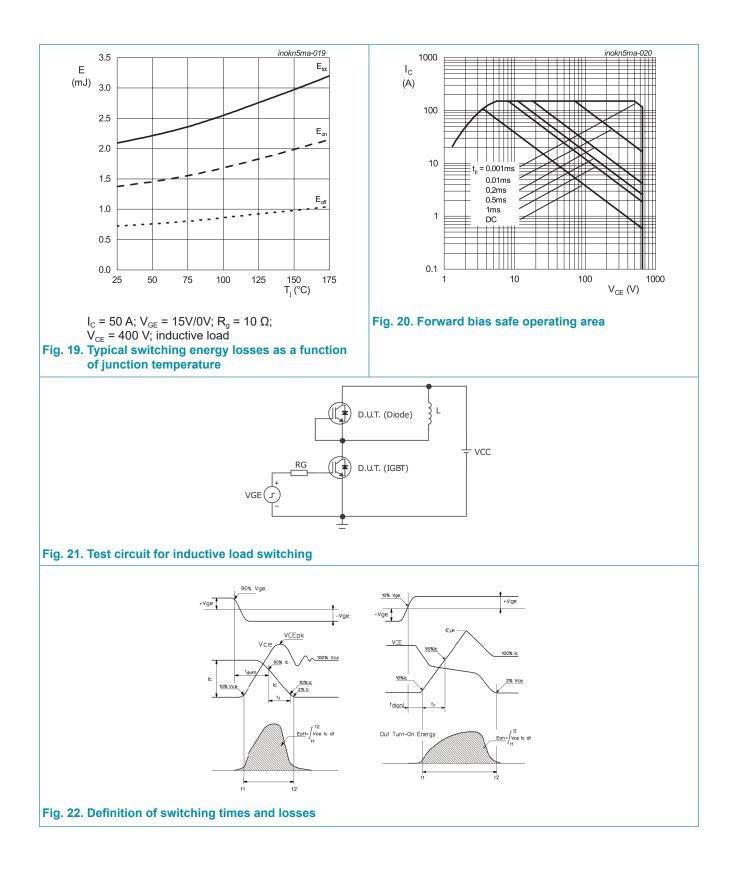
Symbol	Parameter	Conditions	Notes	Min	Тур	Max	Unit
IGBT cha	racteristics						
t _{d(on)}	Turn-on delay time	$T_{j} = 25 \ ^{\circ}C;$		-	44	-	nS
t _r	Rise time	$V_{cc} = 400 \text{ V}; \text{ I}_{c} = 50 \text{ A}; \text{ V}_{GE} = 15 \text{ V} / 0 \text{ V};$ $R_{c} = 10 \Omega$		-	56	-	nS
$t_{\rm d(off)}$	Turn-off delay time			-	200	-	nS
t _f	Fall time			-	36	-	nS
Eon	Turn-on energy			-	1.37	-	mJ
E _{off}	Turn-off energy			-	0.72	-	mJ
E _{ts}	Total switching energy			-	2.09	-	mJ
t _{d(on)}	Turn-on delay time	$T_{j} = 175 \text{ °C};$ $V_{cc} = 400 \text{ V}; I_{c} = 50 \text{ A}; V_{GE} = 15 \text{ V} / 0 \text{ V};$ $R_{G} = 10 \Omega$		-	44	-	nS
t _r	Rise time			-	57	-	nS
$t_{d(off)}$	Turn-off delay time			-	222	-	nS
t _f	Fall time			-	63	-	nS
E _{on}	Turn-on energy			-	2.15	-	mJ
E _{off}	Turn-off energy			-	1.0	-	mJ
E _{ts}	Total switching energy			-	3.15	-	mJ
Diode cha	racteristics	·	,				
t _{rr}	Reverse recovery time	T _j = 25 °C;		-	44	-	nS
Q _r	Reverse recovery charge	$V_{R} = 400 \text{ V}; I_{F} = 30 \text{ A}; dI_{F}/dt = 500 \text{ A}/\text{us}$		-	221	-	nC
I _{RM}	Reverse recovery peak current			-	9	-	A
t _{rr}	Reverse recovery time	T _j = 175 °C;		-	100	-	nS
Q _r	Reverse recovery charge	V_{R} = 400 V; I _F = 30 A; dI _F /dt = 500A/us		-	990	-	nC
I _{RM}	Reverse recovery peak current			-	17	-	A



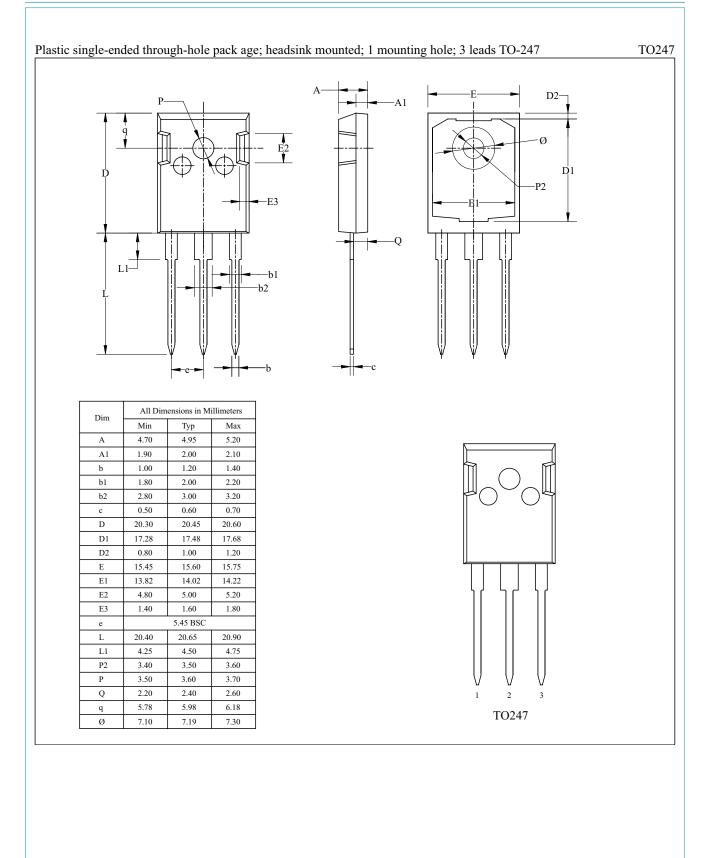
inokn5ma-007 inokn5ma-008 120 3.5 $I_{\rm C}$ $\mathsf{V}_{\mathsf{CEsat}}$ (A) 105 (V) 3.0 90 2.5 75 100A 2.0 60 45 50A 1.5 25A 30 175°C 1.0 25°C 15 0.5 0 0 25 50 75 100 125 150 T_j (°C) 175 12 V_{GE} (V) 2 8 0 4 6 10 14 V_{CE} = 20 V V_{GE} = 15 V Fig. 7. Typical transfer characteristic Fig. 8. Typical collector-emitter saturation voltage as a function of junction temperature inokn5ma-009 inokn5ma-010 8 15 $V_{GE(th)}$ V_{GE} (V) max (V) 12 130V 6 tvc 520V 9 min 4 6 2 3 0 0 150 T_j (°C) 120 Q_G (nC) 0 25 50 75 100 125 175 30 60 90 150 0 I_c = 500 μA $I_{c} = 50 \text{ A}$ Fig. 9. Gate-emitter threshold voltage as a function Fig. 10. Typical gate charge of junction temperature







12. Package outline



WG50N65MAW1

13. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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